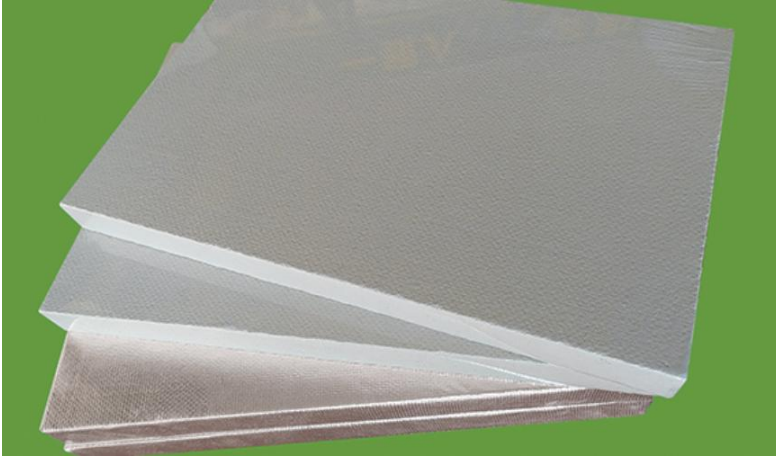


CCEWOOL® M60 Microporous Insulation Board



Temperature Grade: 600°C (1112°F)

CCEWOOL® M60 Microporous Insulation

Board is an efficient insulation product

based on advanced microporous

insulation technology. At low temperature,

it has a lower thermal conductivity than

still air. The thermal conductivity

increases very little with the increase of

temperature. At high temperature, its insulation effect is 3-4 times higher than traditional insulation materials.

CCEWOOL® M60 Microporous Insulation Board has high compressive strength, covered with aluminum

foil or glass fiber cloth. It is an excellent choice for the lightweight and energy-saving application of kiln.

Characteristics:

Good fit to curved surfaces

Low thermal conductivity

Low heat storage

Non-combustibility

Application:

Typical Applications

Back-up insulation in high-temperature furnaces

Appliances insulation

Fire protection equipment

Electronic devices

Nonferrous Metal Furnace

Rotary & Shaft Kiln



Various Incinerator

Reheating Furnace

Permanent Lining For EAF Ladle

General Industrial Furnace etc.

TDS

CCEWOOL® M60 Microporous Insulation Board	
Description	M60 Board
Recommended Temperature of Use (°C)	600 (1112°F)
Density (kg/m³)	300/320
Modules of Rupture (MPa)	≥0.15
Compressive Strength (MPa, 10% relative deformation)	≥0.3
Permanent Linear Shrinkage (%)	600°C x 24h ≤2.0
Thermal Conductivity (W/m·K)	
100°C	0.022
200°C	0.024
300°C	0.028
400°C	0.029
500°C	-
600°C	-
Covering Material	Aluminum Foil / PE Foil / Glass Fiber Cloth
Standard Size (mm)	600 x 400 x (10-50)
	1000 x 500 x (10-50)

